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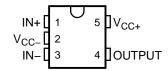
FEATURES

- 1.8-V, 2.7-V, and 5-V Specifications
- Rail-to-Rail Output Swing
 - $-600-\Omega$ Load . . . 80 mV From Rail
 - 2-k Ω Load . . . 30 mV From Rail
- V_{ICR} . . . 200 mV Beyond Rails
- Gain Bandwidth . . . 1.4 MHz
- Supply Current . . . 100 μA/Amplifier
- Max V_{IO} . . . 4 mV
- Space-Saving Packages
 - LMV931: SOT-23 and SC-70
 - LMV932: MSOP and SOIC
 - LMV934: SOIC and TSSOP

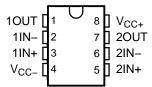
APPLICATIONS

- Industrial (Utility/Energy Metering)
- Automotive
- Communications (Optical Telecom, Data/Voice Cable Modems)
- Consumer Electronics (PDAs, PCs, CDR/W, Portable Audio)
- Supply-Current Monitoring
- Battery Monitoring

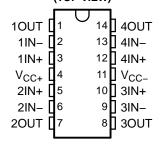
LMV931...DBV (SOT-23-5) OR DCK (SC-70) PACKAGE (TOP VIEW)



LMV932...D (SOIC) OR DGK (VSSOP/MSOP) PACKAGE (TOP VIEW)



LMV934...D (SOIC) OR PW (TSSOP) PACKAGE (TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

ORDERING INFORMATION

T _A		PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING (2)
		SOT-23 – DBV	Reel of 3000	LMV931IDBVR	RBB_
	Cinala	301-23 - DBV	Reel of 250	LMV931IDBVT	PREVIEW
	Single	CC 70 DCV	Reel of 3000	LMV931IDCKR	RB_
		SC-70 – DCK	Reel of 250	LMV931IDCKT	PREVIEW
	Dual	MSOP/VSSOP – DGK	Reel of 2500	LMV932IDGKR	RD_
–40°C to 125°C			Reel of 250	LMV932IDGKT	PREVIEW
-40°C to 125°C		colo D	Tube of 75	LMV932ID	MV932I
		SOIC – D	Reel of 2500	LMV932IDR	WV9321
		SOIC – D	Tube of 50	LMV934ID	LMV934I
	Quad	301C - D	Reel of 2500	LMV934IDR	LIVIV 9341
	Quau	T000D DW	Tube of 90	LMV934IPW	MV934I
		TSSOP – PW	Reel of 2000	LMV934IPWR	IVI V 3041

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

⁽²⁾ DBV/DCK/DGK: The actual top-side marking has one additional character that designates the assembly/test site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

LMV931 SINGLE, LMV932 DUAL, LMV934 QUAD 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT

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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

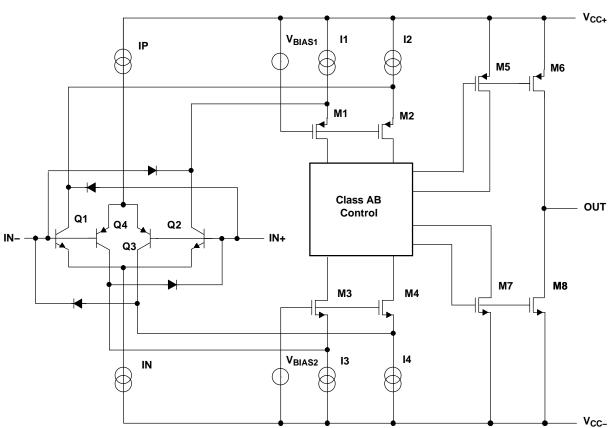
The LMV93x devices are low-voltage low-power operational amplifiers that are well suited for today's low-voltage and/or portable applications. Specified for operation of 1.8 V to 5 V, they can be used in portable applications that are powered from a single-cell Li-ion or two-cell batteries. They have rail-to-rail input and output capability for maximum signal swings in low-voltage applications. The LMV93x input common-mode voltage extends 200 mV beyond the rails for increased flexibility. The output can swing rail-to-rail unloaded and typically can reach 80 mV from the rails, while driving a $600-\Omega$ load (at 1.8-V operation).

During 1.8-V operation, the devices typically consume a quiescent current of 103 μ A per channel, and yet they are able to achieve excellent electrical specifications, such as 101-dB open-loop DC gain and 1.4-MHz gain bandwidth. Furthermore, the amplifiers offer good output drive characteristics, with the ability to drive a 600- Ω load and 1000-pF capacitance with minimal ringing.

The LMV93x devices are offered in the latest packaging technology to meet the most demanding space-constraint applications. The LMV931 is offered in standard SOT-23 and SC-70 packages. The LMV932 is available in the traditional MSOP and SOIC packages. The LMV934 is available in the traditional SOIC and TSSOP packages.

The LMV93x devices are characterized for operation from –40°C to 125°C, making the part universally suited for commercial, industrial, and automotive applications.

SIMPLIFIED SCHEMATIC





LMV931 SINGLE, LMV932 DUAL, LMV934 QUAD 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT

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Absolute Maximum Ratings⁽¹⁾

over free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CC+} - V_{CC-}$	Supply voltage ⁽²⁾			5.5	V
V_{ID}	Differential input voltage (3)		Supply vo	Itage	
V _I	Input voltage range, either input				
	Duration of output short circuit (one ampl	lifier) to V _{CC±} ⁽⁴⁾⁽⁵⁾	Unlimite	ed	
		D package (8 pin)		97	
	5.16	D package (14 pin)		86	
		DBV package		206	00/11/
θ_{JA}	Package thermal impedance ⁽⁵⁾⁽⁶⁾	DCK package		252	°C/W
		DGK package		172	
		PW package		113	
T _J	Operating virtual junction temperature			150	°C
T _{stg}	Storage temperature range		-65	150	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
- 3) Differential voltages are at IN+ with respect to IN-.
- (4) Applies to both single-supply and split-supply operation. Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.
- (5) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

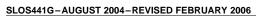
Recommended Operating Conditions

		MIN	MAX	UNIT
V _{CC}	Supply voltage (V _{CC+} – V _{CC-})	1.8	5	V
T _A	Operating free-air temperature	-40	125	°C

ESD Protection

	TYP	UNIT
Human-Body Model	2000	V
Machine Model	200	V

LMV931 SINGLE, LMV932 DUAL, LMV934 QUAD 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT





Electrical Characteristics

 $\rm V_{CC+} = 1.8~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

	PARAMETE	R	TEST COND	ITIONS	T _A	MIN	TYP	MAX	UNIT	
			LM\/024 (ain ala)		25°C		1	4		
.,	land offerstoo	-11	LMV931 (single)		Full range			6		
V_{IO}	Input offset v	oitage	LM\(000 (dal) LM\(00) ((25°C		1	5.5	mV	
			LMV932 (dual), LMV93	34 (quad)	Full range			7.5		
$\alpha_{V_{\text{IO}}}$	Average temposers of coefficient of offset voltage	input			25°C		5.5		μV/°C	
			$V_{IC} = V_{CC+} - 0.8 \text{ V}$		25°C		15	35		
I_{IB}	Input bias cu	rrent			25°C			65	nA	
					Full range			75		
	Innut offeet o				25°C		13	25	~ ^	
I _{IO}	Input offset c	urrent			Full range			40	nA	
	Supply curre	nt			25°C		103	185	^	
I _{CC}	(per channel)				Full range			205	μΑ	
				25°C	60	78				
CMRR	Common-mode rejection ratio		$0 \le V_{IC} \le 0.6 \text{ V}, 1.4 \text{ V}$	≤ V _{IC} ≤ 1.8 V	-40°C to 85°C	55			dB	
CIVIKK			$0.2 \le V_{IC} \le 0.6 \text{ V}, 1.4 \text{ V}$	/ ≤ V _{IC} ≤ 1.6 V	–40°C to 125°C	55			uВ	
			$-0.2 \le V_{IC} \le 0 \text{ V}, 1.8 \text{ V}$	\leq V _{IC} \leq 2 V	25°C	50	72			
l,	Supply-voltag	ge	191/21/251/1/	- 0 F V	25°C	75	100		٩D	
k _{SVR}	rejection ratio		$1.8 \text{ V} \le \text{V}_{\text{CC+}} \le 5 \text{ V}, \text{ V}_{\text{IC}}$	5 = 0.5 V	Full range	70			dB	
					25°C	V _{CC} 0.2	-0.2 to 2.1	V _{CC+} + 0.2		
V_{ICR}	Common-mode input voltage range		CMRR ≥ 50 dB		–40°C to 85°C	V _{CC} -		V _{CC+}	V	
	put romago	·ungo						V _{CC+} - 0.2		
				$R_L = 600 \Omega$	25°C	77	101			
		LMV931		to 0.9 V	Full range	73			 	
		LIVIV931		$R_L = 2 k\Omega$	25°C	80	105			
٨	Large-signal		$V_0 = 0.2 \text{ V to } 1.6 \text{ V},$	to 0.9 V	Full range	75			dB	
A_V	voltage gain		$V_{IC} = 0.5 \text{ V}$	$R_L = 600 \Omega$	25°C	75	90		иь	
		LMV932,		to 0.9 V	Full range	72				
		LMV934		$R_L = 2 k\Omega$	25°C	78	100			
				to 0.9 V	Full range	75				
				I limb lavel	25°C	1.65	1.72			
			$R_L = 600 \Omega \text{ to } 0.9 \text{ V},$	High level	Full range	1.63				
			$V_{ID} = \pm 100 \text{ mV}$		25°C		0.077	0.105		
.,	0			Low level	Full range			0.120	.,	
Vo	Output swing			I Cale Joseph	25°C	1.75	1.77		V	
			$R_L = 2 k\Omega$ to 0.9 V,	High level	Full range	1.74				
			$V_{ID} = \pm 100 \text{ mV}$		25°C		0.024	0.035		
				Low level	Full range			0.040		
			V _O = 0 V.		25°C	4	8			
	Output short-	circuit	$V_O = 0 \text{ V},$ $V_{ID} = 100 \text{ mV}$ Sourcing	Full range	3.3			-		
Ios	current	$V_O = 1.8 \text{ V},$	Vo = 1.8 V	0:1:	25°C	7	9		mA	
	Garrone	N' 400 N SIIINIIU	Full range	5			-			



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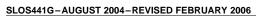
Electrical Characteristics (continued)

 $\rm V_{CC+} = 1.8~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
GBW	Gain bandwidth product		25°C		1.4		MHz
SR	Slew rate ⁽¹⁾		25°C		0.35		V/μS
Φ_{m}	Phase margin		25°C		67		0
	Gain margin		25°C		7		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V	25°C		60		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C		0.06		pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600 \Omega, V_{ID} = 1 V_{p-p}$	25°C		0.023		%
	Amplifier-to-amplifier isolation (2)		25°C		123		dB

Number specified is the slower of the positive and negative slew rates. Input referred, $V_{CC+} = 5 \text{ V}$ and $R_L = 100 \text{ k}\Omega$ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce $V_{O} = 3 V_{p-p}$.

LMV931 SINGLE, LMV932 DUAL, LMV934 QUAD 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT





Electrical Characteristics

 $\rm V_{CC+} = 2.7~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

	PARAMETER		TEST CONDI	TIONS	T _A	MIN	TYP	MAX	UNIT	
		_	LM\/031 (single)		25°C		1	4		
\/	Input offeet :	tage	LMV931 (single)		Full range			6	m\/	
V_{IO}	Input offset vol	iaye	LMV932 (dual), LMV93	RA (auad)	25°C		1	5.5	mV	
			LIVIV 932 (dual), LIVIV93	o+ (quau)	Full range			7.5		
$\alpha_{V_{IO}}$	Average temper coefficient of in offset voltage				25°C		5.5		μV/°C	
			$V_{IC} = V_{CC+} - 0.8 \text{ V}$		25°C		15	35		
I_{IB}	Input bias curr	ent			25°C			65	nA	
					Full range			75		
l _{io}	Input offset cu	rrent			25°C		8	25	nA	
I _{IO}	input onset cui	TICHE			Full range			40	11/4	
laa	Supply current				25°C		105	190	μΑ	
I _{CC}	(per channel)				Full range			210	μΑ	
					25°C	60	81		-	
CMRR	MRR Common-mode		$0 \le V_{IC} \le 1.5 \text{ V}, 2.3 \text{ V} \le$	≤ V _{IC} ≤ 2.7 V	−40°C to 85°C	55			dB	
OWNER	rejection ratio		$0.2 \le V_{IC} \le 1.5 V, 2.3 V$	–40°C to 125°C	55			45		
			$-0.2 \le V_{IC} \le 0 \text{ V}, 2.7 \text{ V}$	$\leq V_{IC} \leq 2.9 \text{ V}$	25°C	50	74			
k	Supply-voltage)	$1.8 \text{ V} \le \text{V}_{\text{CC+}} \le 5 \text{ V}, \text{ V}_{\text{IC}} = 0.5 \text{ V}$		25°C	75	100		dB	
k _{SVR}	rejection ratio		$1.0 \text{ V} \leq \text{V}_{CC+} \leq 5 \text{ V}, \text{V}_{IC}$	5 = 0.5 V	Full range	70			uБ	
					25°C	V _{CC} 0.2	-0.2 to 3	V _{CC+} + 0.2		
V_{ICR}	Common-mode input voltage range		CMRR ≥ 50 dB		−40°C to 85°C	V _{CC} -		V _{CC+}	V	
				–40°C to 125°C	V _{CC-} + 0.2		V _{CC+} - 0.2			
			021	$R_L = 600 \Omega$	25°C	87	104			
		L MV (024		to 1.35 V $R_L = 2 k\Omega$	Full range	86				
		LMV931	LMV931		25°C	92	110			
^	Large-signal		V 0.2.V to 2.5.V	to 1.35 V	Full range	91			٩D	
A_V	voltage gain		$V_0 = 0.2 \text{ V to } 2.5 \text{ V}$	$R_L = 600 \Omega$	25°C	78	90		dB	
		LMV932,		to 1.35 V	Full range	75				
		LMV934		$R_L = 2 k\Omega$	25°C	81	100			
				to 1.35 V	Full range	78				
				High laws	25°C	2.55	2.62			
			$R_L = 600 \Omega \text{ to } 1.35 \text{ V},$	High level	Full range	2.53				
			$V_{ID} = \pm 100 \text{ mV}$	1 1	25°C		0.083	0.11		
. ,	.			Low level	Full range			0.13		
Vo	Output swing				25°C	2.65	2.675		V	
			$R_L = 2 k\Omega \text{ to } 1.35 \text{ V},$	High level	Full range	2.64				
			$V_{ID} = \pm 100 \text{ mV}$		25°C		0.025	0.04		
				Low level	Full range			0.045		
			V _O = 0 V,		25°C	20	30			
	Output short-c	ircuit	$V_{ID} = 100 \text{ mV}$	Sourcing	Full range	15				
los	current		V 2 7 V	25°C	18	25		mA		
	Carron		$V_O = 2.7 \text{ V},$ $V_{ID} = -100 \text{ mV}$ Sinking	Full range	12					
GBW	Gain bandwidt	h product	10		25°C		1.4		MHz	



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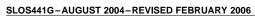
Electrical Characteristics (continued)

 $\rm V_{CC+} = 2.7~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

	PARAMETER	TEST CONDITIONS	T _A	MIN TYP	MAX	UNIT
SR	Slew rate ⁽¹⁾		25°C	0.4		V/μS
Φ_{m}	Phase margin		25°C	70		0
	Gain margin		25°C	7.5		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V	25°C	57		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C	0.082		pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600 \Omega, \ V_{ID} = 1 V_{p-p}$	25°C	0.022		%
	Amplifier-to-amplifier isolation ⁽²⁾		25°C	123		dB

 ⁽¹⁾ Number specified is the slower of the positive and negative slew rates.
 (2) Input referred, V_{CC+} = 5 V and R_L = 100 kΩ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce V_O = 3 V_{p-p}.

LMV931 SINGLE, LMV932 DUAL, LMV934 QUAD 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT





Electrical Characteristics

 $\rm V_{CC+} = 5~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

P	PARAMETER	1	TEST CONDI	TIONS	T _A	MIN	TYP	MAX	UNIT	
			1.00/004 (:: 1.)		25°C		1	4		
			LMV931 (single)		Full range			6		
V _{IO} Ir	nput offset vo	oltage			25°C		1	5.5	mV	
			LMV932 (dual), LMV934 (quad)		Full range			7.5		
$^{lpha_{V}}$ IO c	Average temp coefficient of offset voltage	input			25°C		5.5		μV/°C	
	<u></u>		$V_{IC} = V_{CC+} - 0.8 \text{ V}$		25°C		15	35		
_{IB} Ir	nput bias cur	rent	.0 001		25°C			65	nA	
.5				Full range			75			
					25°C		9	25		
ıo Ir	nput offset c	urrent			Full range			40	nA	
	Supply currer	nt.			25°C		116	210		
	per channel)	ıı			Full range			230	μΑ	
	. ,				25°C	60	86	200		
C	Common-mode		$0 \le V_{IC} \le 3.8 \text{ V}, 4.6 \text{ V}$	≤ V _{IC} ≤ 5 V	-40°C to 85°C	55				
	ejection ratio		$0.3 \le V_{IC} \le 3.8 \text{ V}, 4.6 \text{ V}$	V ≤ V _{IC} ≤ 4.7 V	–40°C to 125°C	55			dB	
			$-0.2 \le V_{IC} \le 0 \text{ V}, 5 \text{ V} \le$	≤ V _{IC} ≤ 5.2 V	25°C	50	78			
	Supply-voltag	e			25°C	75	100			
	ejection ratio		1.8 $V \le V_{CC+} \le 5 V, V_{10}$	$_{\rm C} = 0.5 \text{ V}$	Full range	70			dB	
					25°C	V _{CC} 0.2	-0.2 to 5.3	V _{CC+} + 0.2		
Common-mode inpu		CMRR ≥ 50 dB	–40°C to 85°C	V _{CC} -		V _{CC+}	V			
V	ICR voltage range			–40°C to 125°C	V _{CC} -+ 0.3		V _{CC+} - 0.3			
		LMV931		R _L = 600 Ω to 2.5 V	25°C	88	102			
					Full range	87				
				$R_L = 2 k\Omega$	25°C	94	113			
. 1	_arge-signal			to 2.5 V	Full range	93				
	oltage gain		$V_0 = 0.2 \text{ V to } 4.8 \text{ V}$	R _L = 600 Ω	25°C	81	90		dB	
		LMV932,		to 2.5 V	Full range	78				
		LMV934		$R_L = 2 k\Omega$	25°C	85	100			
				to 2.5 V	Full range	82				
					25°C	4.855	4.89			
			D 000 0 to 0 5 1/	High level	Full range	4.835	4.00			
			$R_L = 600 \Omega \text{ to } 2.5 \text{ V},$ $V_{ID} = \pm 100 \text{ mV}$		25°C	4.055	0.12	0.16		
			- ID =	Low level	Full range		0.12	0.18		
/ ₀ C	Output swing					4.045	4.007	0.10	V	
				High level	25°C	4.945	4.967			
			$R_L = 2 \text{ k}\Omega \text{ to } 2.5 \text{ V},$ $V_{ID} = \pm 100 \text{ mV}$		Full range	4.935	0.007	0.005		
			AID - TIOOIIIA	Low level	25°C		0.037	0.065		
					Full range			0.075		
			$V_0 = 0 V$	Sourcing	25°C	80	100		-	
	Output short-			Full range	68			mA		
oo c	current		V _O = 5 V, Sinking		25°C	58	65		11174	
		$V_{ID} = -100 \text{ mV}$ Sinking		Full range	45					



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Electrical Characteristics (continued)

 $\rm V_{CC+} = 5~V,~V_{CC-} = 0~V,~V_{IC} = V_{CC+}/2,~V_O = V_{CC+}/2,~and~R_L > 1~M\Omega~(unless~otherwise~noted)$

	PARAMETER	TEST CONDITIONS	TA	MIN	TYP	MAX	UNIT
GBW	Gain bandwidth product		25°C		1.5		MHz
SR	Slew rate ⁽¹⁾		25°C		0.42		V/μS
Φ_{m}	Phase margin		25°C		71		0
	Gain margin		25°C		8		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V	25°C		50		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C		0.07		pA/√ Hz
THD	Total harmonic distortion	$ f = 1 \text{ kHz}, A_V = 1, R_L = 600 \ \Omega, $ $V_{ID} = 1 \ V_{p-p} $	25°C		0.022		%
	Amplifier-to-amplifier isolation (2)		25°C		123		dB

 ⁽¹⁾ Number specified is the slower of the positive and negative slew rates.
 (2) Input referred, V_{CC+} = 5 V and R_L = 100 kΩ connected to 2.5 V. Each amplifier is excited, in turn, with a 1-kHz signal to produce $V_{O} = 3 V_{p-p}$.

Figure 3.



TYPICAL CHARACTERISTICS

 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)

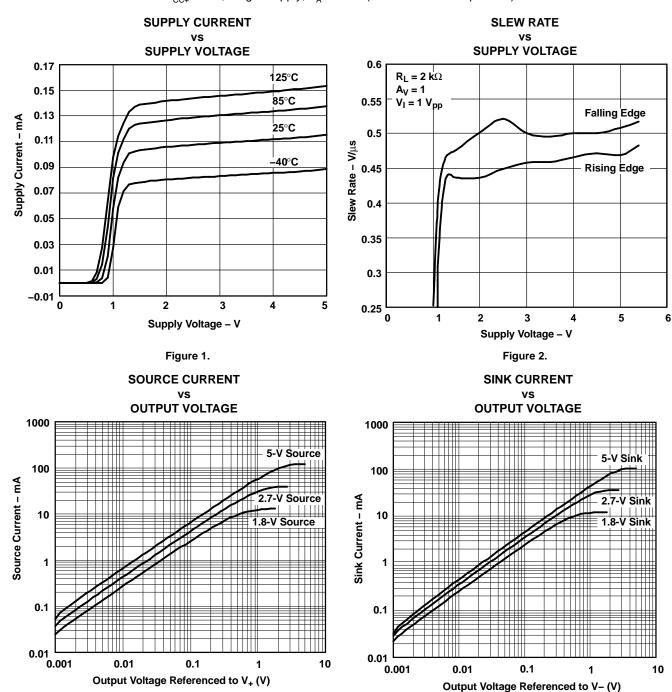


Figure 4.

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TYPICAL CHARACTERISTICS (continued)

 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)

Figure 7.

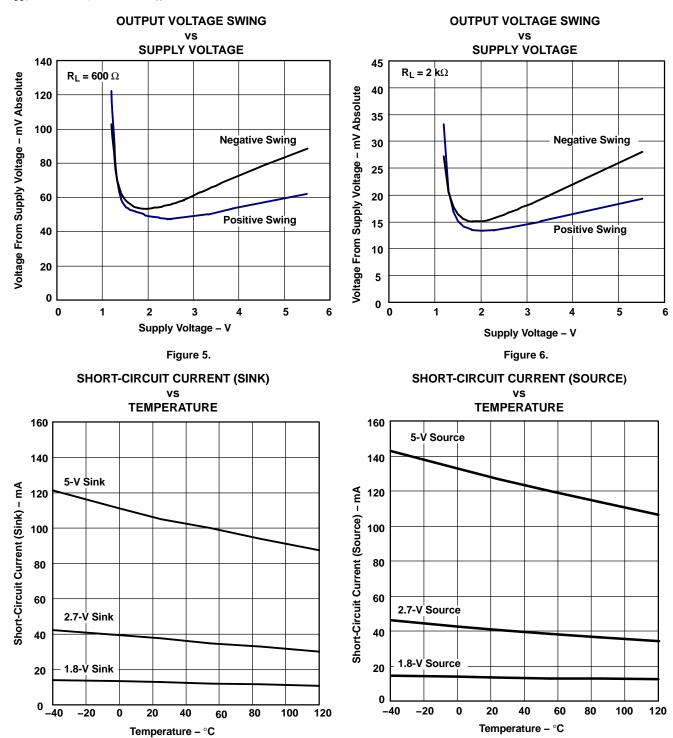


Figure 8.

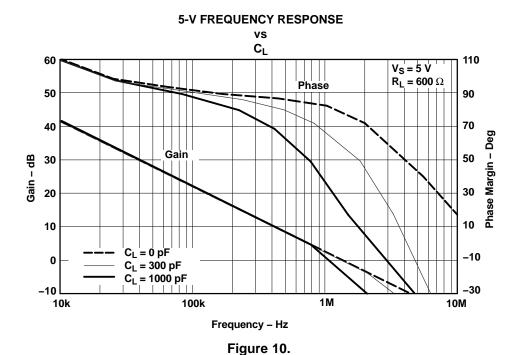


 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)

1.8-V FREQUENCY RESPONSE vs C_L 110 60 V_S = 1.8 V Phase $R_L = 600 \Omega$ 90 50 70 40 Phase Margin - Deg 50 Gain 30 Gain - dB 30 20 10 -10 $C_L = 0 pF$ 0 $C_L = 300 pF$ $C_L = 1000 pF$ 100k 1M 10M 10k

Figure 9.

Frequency - Hz



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 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)

1.8-V FREQUENCY RESPONSE

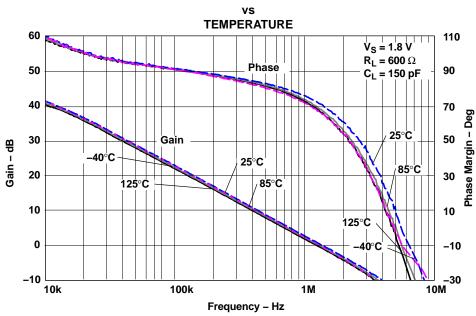


Figure 11.

5-V FREQUENCY RESPONSE

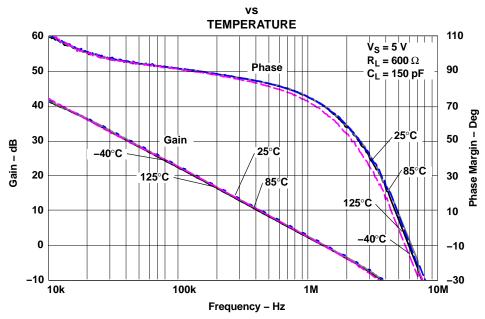
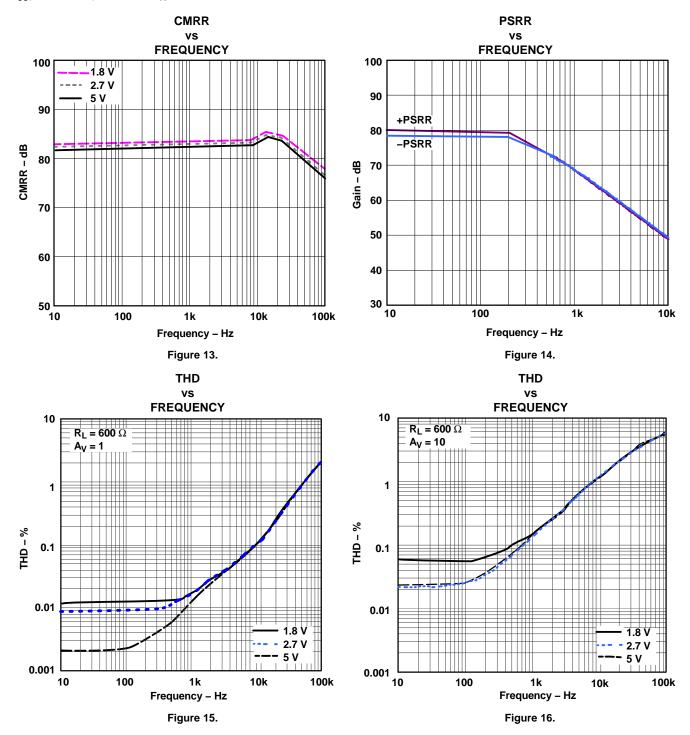


Figure 12.



 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)



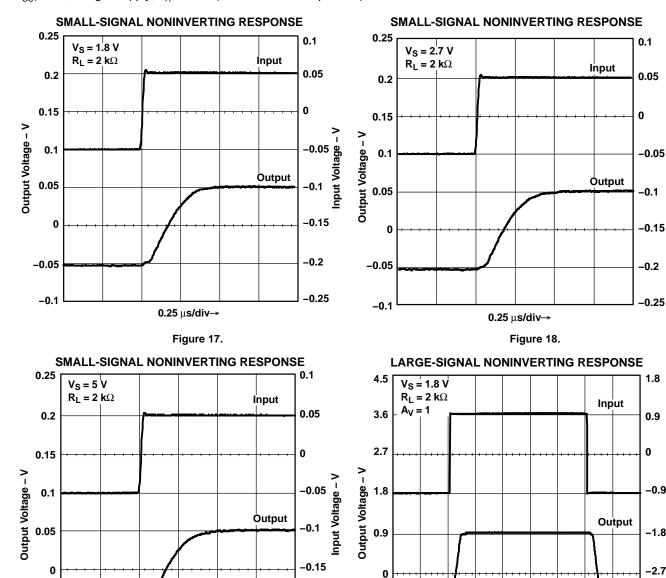
-0.05

-0.1

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TYPICAL CHARACTERISTICS (continued)

 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)



-0.2

-0.25

-0.9

-1.8

Figure 19.

0.25 μs/div→

Figure 20.

10 μs/div→

Input Voltage -

1.8

0.9

0

88 -0-9 Input Voltage - V

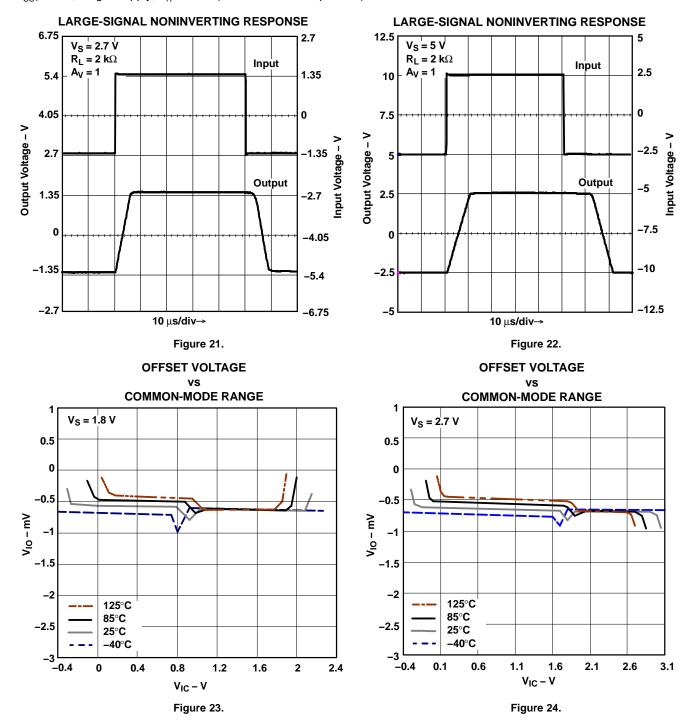
-2.7

-3.6

-4.5



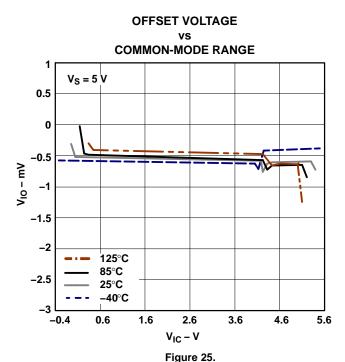
 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)



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TYPICAL CHARACTERISTICS (continued)

 $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$ (unless otherwise specified)





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LMV931IDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV931IDBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV931IDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV931IDCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV931IDCKRE4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV931IDCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV932IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934ID	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IDE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IDG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IDR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IDRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IPWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV934IPWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM



PACKAGE OPTION ADDENDUM

18-Sep-2008

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pa	ackage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LMV934IPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF LMV931:

Automotive: LMV931-Q1

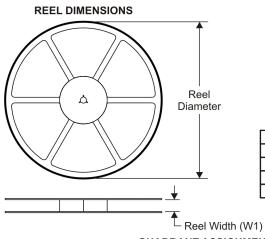
NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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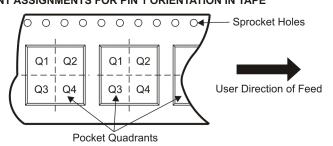
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV931IDBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
LMV931IDBVR	SOT-23	DBV	5	3000	180.0	9.2	3.23	3.17	1.37	4.0	8.0	Q3
LMV931IDCKR	SC70	DCK	5	3000	180.0	9.2	2.24	2.34	1.22	4.0	8.0	Q3
LMV932IDGKR	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV932IDGKR	MSOP	DGK	8	2500	330.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1
LMV932IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LMV934IDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LMV934IPWR	TSSOP	PW	14	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV931IDBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
LMV931IDBVR	SOT-23	DBV	5	3000	205.0	200.0	33.0
LMV931IDCKR	SC70	DCK	5	3000	205.0	200.0	33.0
LMV932IDGKR	MSOP	DGK	8	2500	358.0	335.0	35.0
LMV932IDGKR	MSOP	DGK	8	2500	370.0	355.0	55.0
LMV932IDR	SOIC	D	8	2500	340.5	338.1	20.6
LMV934IDR	SOIC	D	14	2500	346.0	346.0	33.0
LMV934IPWR	TSSOP	PW	14	2000	346.0	346.0	29.0

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



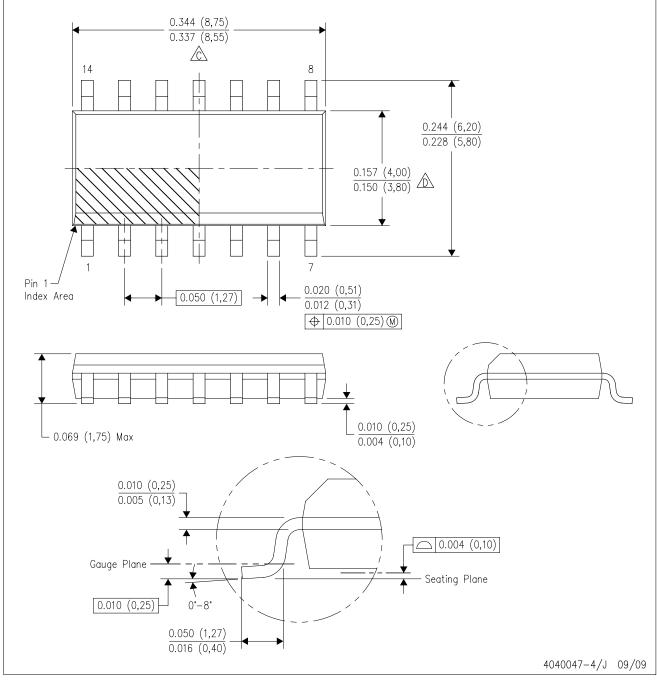
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

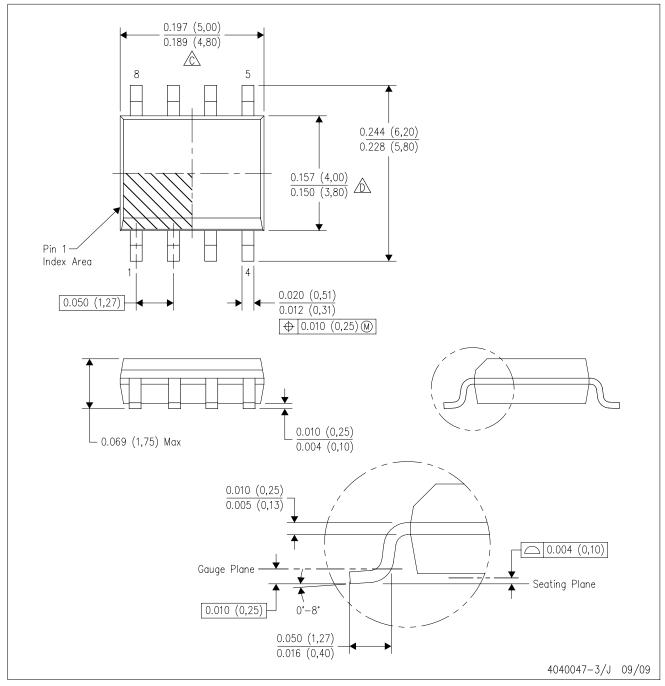


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



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